

Features:

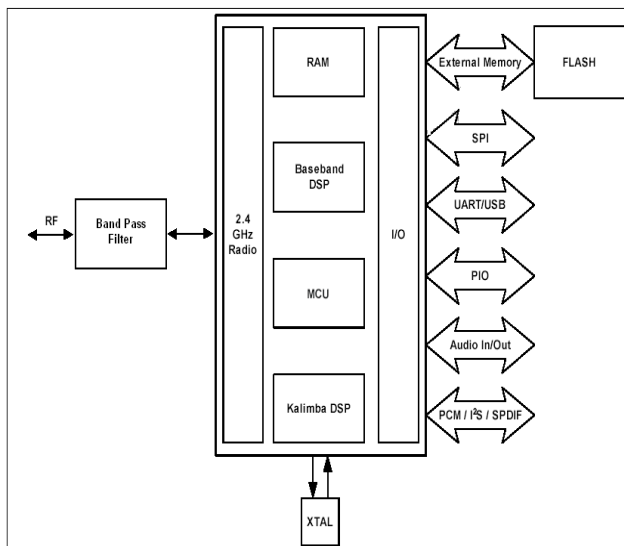
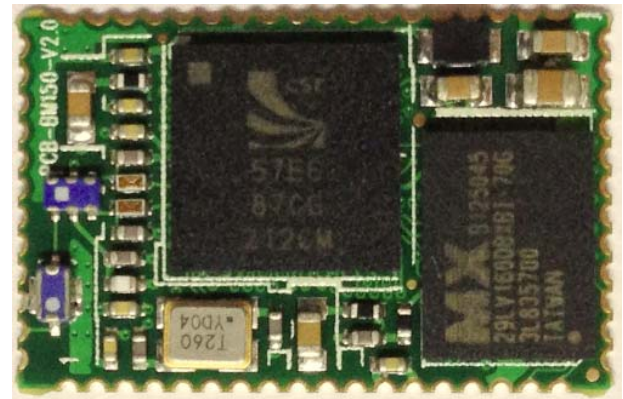
- Bluetooth Spec. V3.0 (V2.1+EDR)Compliant
- Class 2 type Output Power
- Support Firmware Upgrade
- USB 1.1 and UART Host Interface
- Multi-Configurable I2S, PCM or SPDIF Interface
- Integrated Switched-Mode Regulator
- Integrated Battery Charger
- Integrated Microphone bias
- Integrated LED Driver
- Built in 16-bit Stereo Codec- 95dB SNR for DAC
- Factory configurable to either 1.8V or 3.3V supply.
- Supports up to 32Mbits of External Flash Memory (16Mbits Typical Requirement)
- Enhanced Audibility and Noise Cancellation
- PCB material:FR4
- PCB Surface treatment: Immersion gold
- Size: 21mm x 13.5 mm x 2.35mm
- Weight: 0.8g

BM153 Class 2 Multimedia Module



CSR, BC57E687C

Jan. 2013



System Architecture

Product Description:

The BM153 is a Class 2 Bluetooth sub-system using BlueCore5-Multimedia External chipset from leading Bluetooth chipset supplier Cambridge Silicon Radio.

BM153 interfaces to 8Mbit of external Flash memory. When used with the CSR Bluetooth software stack, it provides a fully compliant Bluetooth system to V3.0 of the specification for data and voice communications.

The module and device firmware is fully compliant with the Bluetooth specification V3.0.

Applications:

- Hands-free Car Kit
- Stereo Headset
- AV Headphones
- Echo Cancellation
- High Performance Mono Headsets
- Analogue and USB Multimedia Dongles
- Wireless Speakers

Specifications:

Operating Frequency Band	2.4GHz ~ 2.48GHz unlicensed ISM band
Bluetooth Specification	BT V3.0 (V2.1+EDR)
Output Power Class	Class 2
Max. Output Power	2.5mW
Date Rate	3Mbps
Channel No.	79
Modulation Type	GFSK $\pi/4$ DQPSK 8DPSK
Operating Voltage	1.8V / 3.3V
Host Interface	USB 1.1 or UART
Audio Interface	PCM, I2S, SPDIF
Flash Memory Size	8M,16M, or 32Mbits
Dimension	21mm (L) x 13.5 (W) mm x 2.35mm (H)

Specifications are subject to change without prior notice

Electrical Characteristics

Absolute Maximum Rating	Min	Max
Storage Temperature	-40°C	+85°C
Supply Voltage, (V_CHG)	-0.30V	+6.5V

Recommended Operating Conditions	Min	Max
Operating Temperature Range	-20°C	+70°C
Supply Voltage, (V_BAT)	2.5V	4.2V
Supply Voltage, (V_CHG)	4.5V	5.75V

Power Consumption	Units	Average
SCO Connection HV3 (30ms interval sniff mode)	mA	21
SCO Connection HV1	mA	40
ACL Data Transfer 115.2Kbps UART no traffic (Master)	mA	4.4
ACL Data Transfer 115.2Kbps UART no traffic (Slave)	mA	15
CODEC		
Microphone inputs and ADC/channel	mA	TBD
DAC and loudspeaker driver, no signal/channel	mA	TBD
Digital audio processing subsystem	mA	TBD

VBAT = 4.2V; f = 2.441GHz; T=20°C

RF Characteristics

Receiver	Units	Min	Typ	Max	Bluetooth Spec
Sensitivity at 0.1% BER	dBm	-	-90	-86	≤ -70
Maximum Receiver Signal	dBm	-20	-10	-	≥ -20
C/I Co-Channel	dB	-	6	11	≤ 11
Adjacent Channel Selectivity C/I -1MHz	dB	-	-6	0	≤ 0
2nd Adjacent Channel Selectivity C/I -2MHz	dB	-	-38	-30	≤ -30
3rd Adjacent Channel Selectivity C/I -3MHz	dB	-	-45	-40	≤ -40
Image Rejection C/I	dB	-	-16	-9	≤ -9

VBAT = 4.2V; f = 2.4441GHz; T=20°C

Transmitter	Units	Min	Typ	Max	Bluetooth Spec
RF Output Power	dBm	0	3	-	-6 to +4
RF Power Control Range	dB	16	24	-	> 16
RF Power Range Control Resolution	dB	-	0.5	-	-
20dB Bandwidth for Modulated Carrier	KHz	-	940	1000	<1000
2nd Adjacent Channel Power (+/- 2MHz)	dBm	-	-36	-20	≤ -20
3rd Adjacent Channel Power (+/- 3MHz)	dBm	-	-45	-40	≤ -40

VBAT = 4.2V; f = 2.4441GHz; T=20°C

All specifications including pinouts and electrical specifications may be changed without prior notice

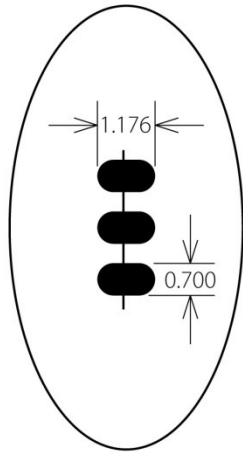
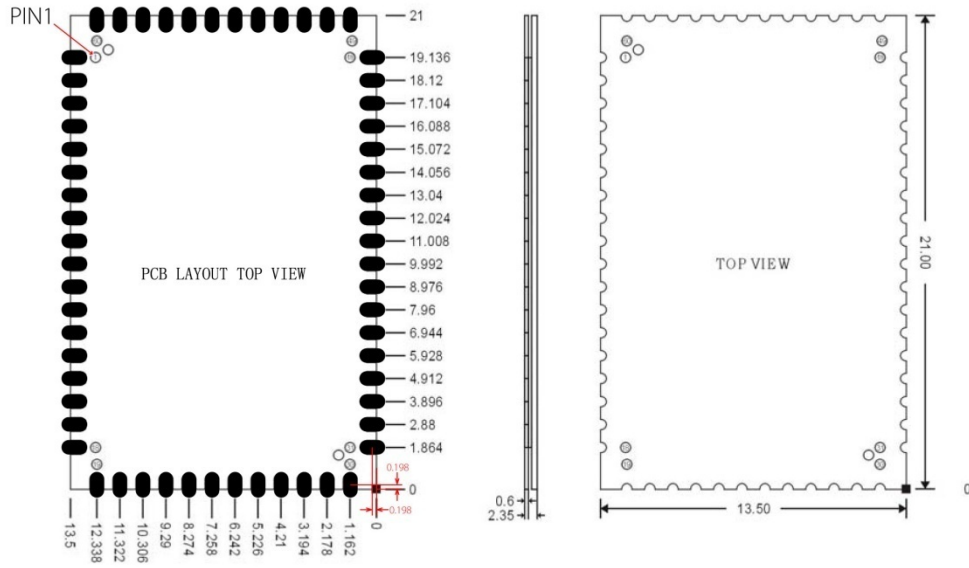


Pin Configurations

PIN NO.	NAME	TYPE	FUNCTION	RE-MARK
1	AIO1	Bi-directional	Programmable input/output line	
2	AIO0	Bi-directional	Programmable input/output line	
3	RESET	CMOS input with weak internal pull-up	Reset if low. Input debounced so must be low for >5ms to cause a reset	
4	GND	GND	Ground	
5	PIO9	Bi-directional	Programmable Input/Output Line	
6	PIO10	Bi-directional	Programmable Input/Output Line	
7	PIO11	Bi-directional	Programmable Input/Output Line	
8	PIO12	Bi-directional	Programmable Input/Output Line	
9	PIO13	Bi-directional	Programmable Input/Output Line	
10	PIO14	Bi-directional	Programmable Input/Output Line	
11	PIO15	Bi-directional	Programmable Input/Output Line	
12	GND	GND	Ground	
13	VDD	Power	+3.3V Supply	For 3.3V Version
	VDD	Power	Connect to +1V8	For 1.8V Version
14	VDD_USB	Power	Positive supply for UART/USB ports, Connect to VDD	
15	+1V8	Power	+1.8V Supply	
16	GND	GND	Ground	
17	USB_DP	Bi-directional	USB Data Plus	
18	USB_DN	Bi-directional	USB Data Minus	
19	UART_RTS	CMOS Output	UART Request To Send (Active Low)	
20	UART_CTS	CMOS Input	UART Clear To Send (Active Low)	
21	UART_RX	CMOS Input	UART Data Input (Active High)	
22	UART_TX	CMOS Output	UART Data Output (Active High)	
23	PCM_IN	CMOS Input	Synchronous Data Input	
24	PCM_SYNC	Bi-directional	Synchronous Data Sync	
25	PCM_CLK	Bi-directional	Synchronous Data Clock	
26	PCM_OUT	CMOS Output	Synchronous Data Output	
27	SPI_CSB	CMOS Input	Chip Select For Synchronous Serial Interface (Active Low)	
28	SPI_MISO	CMOS Output	Serial Peripheral Interface Data Output	
29	SPI_CLK	CMOS Input	Serial Peripheral Interface Clock	
30	SPI_MOSI	CMOS Input	Serial Peripheral Interface Data Input	
31	VRE_IN	Analogue	Take high to enable switch-mode regulator	
32	VDD_BAT	Battery terminal +ve	Lithium ion/polymer battery positive terminal. Battery charger output and input to switch-mode regulator	
33	GND	GND	Ground	
34	VDD_CHG	Charger input	Lithium ion/polymer battery charger input	
35	LED1	Open drain output	LED Driver	
36	LED0	Open drain output	LED Driver	
37	GND	GND	Ground	
38	SPK_L_N	Analogue	Speaker output negative, left	
39	SPK_L_P	Analogue	Speaker output positive, left	
40	SPK_R_N	Analogue	Speaker output negative, right	
41	SPK_R_P	Analogue	Speaker output positive, right	
42	GND_S	GND S	Analogue Signal Ground	
43	MIC_BIAS	Analogue	Microphone bias	
44	MIC_B_P	Analogue	Microphone input positive, right	
45	MIC_B_N	Analogue	Microphone input negative, right	
46	MIC_A_P	Analogue	Microphone input positive, left	
47	MIC_A_N	Analogue	Microphone input negative, left	
48	GND	GND	Ground	
49	PIO0	Bi-directional	Programmable Input/Output Line	
50	PIO1	Bi-directional	Programmable Input/Output Line	
51	PIO2	Bi-directional	Programmable Input/Output Line	
52	PIO3	Bi-directional	Programmable Input/Output Line	
53	PIO4	Bi-directional	Programmable Input/Output Line	
54	PIO5	Bi-directional	Programmable Input/Output Line	
55	PIO6	Bi-directional	Programmable Input/Output Line	
56	PIO7	Bi-directional	Programmable Input/Output Line	
57	PIO8	Bi-directional	Programmable Input/Output Line	
58	GND	GND	Ground	
59	RF-IN	RF	RF Interface	
60	GND	GND	Ground	

Recommended Layout patterns:

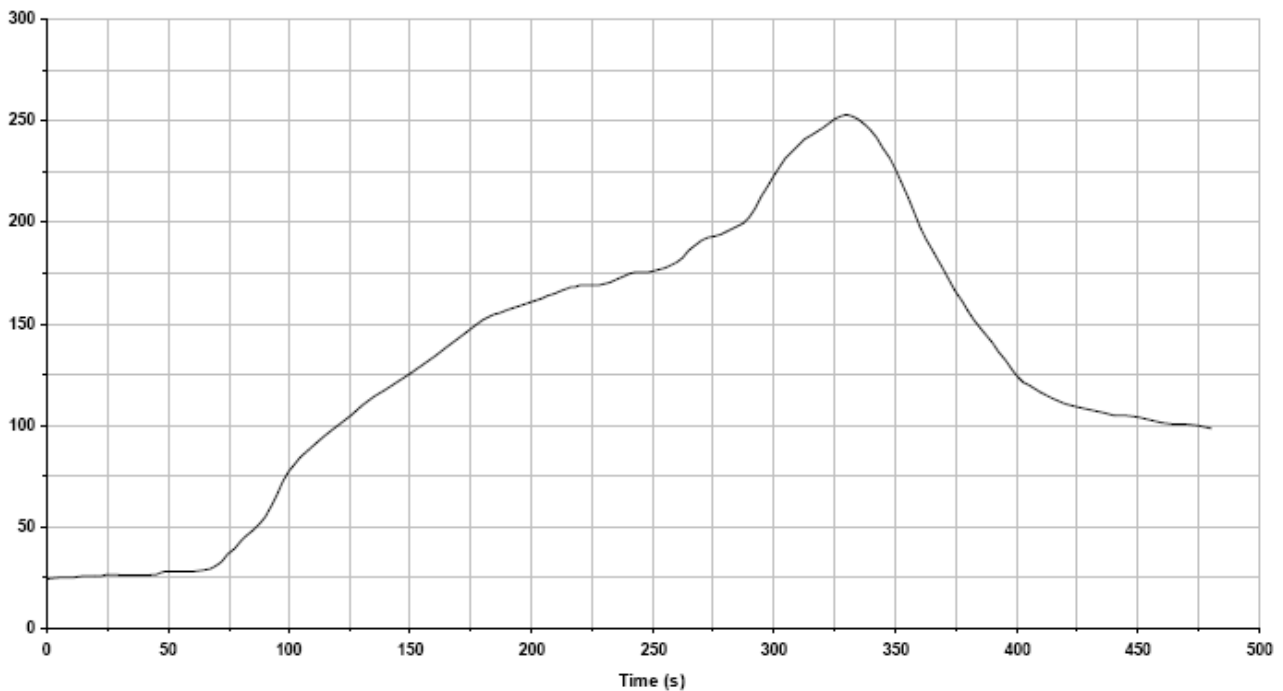
Physical Dimension Unit in mm



NO	PINNAME	NO	PINNAME
1	A101	31	VRE_IN
2	A100	32	VDD_BAT
3	RESET	33	GND
4	GND	34	VDD_CHG
5	P109	35	LEO1
6	P1010	36	LEO0
7	P1011	37	GND
8	P1012	38	SPK_L_N
9	P1013	39	SPK_L_P
10	P1014	40	SPK_R_N
11	P1015	41	SPK_R_P
12	GND	42	GND_S
13	VDD	43	MIC_BIAS
14	VDD_USB	44	MIC_B_P
15	+1V8	45	MIC_B_N
16	GND	46	MIC_A_P
17	USB_DP	47	MIC_A_N
18	USB_DN	48	CND
19	UART_RTS	49	PIDO
20	USRT_CTS	50	PIO1
21	UART_RX	51	PIO2
22	UART_TX	52	PIO3
23	PCM_IN	53	PIO4
24	PCM_SYNC	54	PIO5
25	PCM_CLK	55	PIO6
26	PCM_OUT	56	PIO7
27	SPI_CSB	57	PIO8
28	SPI_MISO	58	GND
29	SPI_CLK	59	RF
30	SPI_MOSI	60	GND

Configuration

Recommended Reflow Temperature Profile:



Key features of the profile:

- Initial Ramp=1-2.5°C/sec to 175°C equilibrium
- Equilibrium time=60 to 80 seconds
- Ramp to Maximum temperature (250°C)=3°C/sec Max
- Time above liquidus temperature(217°C): 45 - 90 seconds
- Device absolute maximum reflow temperature: 250°C

MAC Address:

Each Module has his MAC Address

001D DF XXXXXX

Concerning the dimension of the tab, only printing the last six letters of the LAP on the module.



The tab code pastes style:



QDL Certificate



Bluetooth SIG Qualification Design (QDL) Certificate

QDL Certificate: This certificate represents the Specifications declared by the Member as having passed the Bluetooth Qualification/Certification Process as specified within the Bluetooth Specifications and as required within the PRD 2.0.

Design Name: **Bluetooth Class 2 Multimedia Module (v2.1+EDR)**

This Product Design has passed the Bluetooth Qualification Process!



Specification Version: 2.1/2.1+EDR

QDID: B014839

Declared Specifications: Baseband Conformance, Radio, Link Manager, Summary ICS, Product Type

Member Company:
Sunitec
10F.-1, No.200, Jingping Rd.
Jhonghe City, Taipei County
23581 T

Requirements:
1. Testing
2. Documentation
3. Assessment
4. Declaration
5. Listing
6. Marking
7. Compliance to Auditing and Enforcement

Project Dates:
Assessment Date:
December/08/2008

Listing Date:
December/08/2008

BQE:
H.M. Chen

Qualified Design ID (QD ID)	B014839 Export PICS		
PRD 1.0 ID (QP ID)			
Design Name	Bluetooth Class 2 Multimedia Module (v2.1+EDR)		
Wi-Fi® Certification ID			
Subsetted Designs	Date Created	Type	PICS
	Dec 7, 2008	Main	PICS
Member Company	Sunitec		
Specification Name	2.1+EDR		
Core Spec Addenda	N/A		
Design Model Number	BM150, BM151, BM153, BMXXX		
Hardware Version Number	V1.0		
Software Version Number	N/A		
Qualification Assessment Date	November/24/2011		
Listing Date	December/08/2008		
Design Description	Bluetooth Class 2 Multimedia Module		
Product Type	Component (Tested)		
Technical Data Sheet (RIN)	** Open Reference Integration Notes (RIN) **		
Listed By	li yuanshun		
BQE	H.M. Chen		

Ordering Information

No	Items	Ordering Code (Class 2)	Description
1	BC05mm-ext Module-3V3	BM153	16Mbit Flash Operating Voltage is 3.3V
2	BC05mm-ext Module-3V3	BM153-08	8Mbit Flash Operating Voltage is 3.3V
3	BC05mm-ext Module-3V3	BM153-32	32Mbit Flash Operating Voltage is 3.3V
4	BC05mm-ext Module Test Kit	BM153 TK	Test kit base BM153



Document References

References	Version
Specifications of the Bluetooth System	V2.1+EDR, 26 July 2007
BlueCore5-Multimedia External Product Data Sheet	CS-121064-DSP2 15 July 2008

Document History

Revision	Date	History
Draft V0.1	2006-12-12	
V1.0	2007-04-12	First release
V2.0	2008-09-11	Update from Revision V1.0
V3.0	2008-09-19	Update from Revision V2.0
V4.0	2009-05-22	Update from V2.0+EDR compliant to V2.1+EDR compliant
V4.1	2009-07-30	Update from printing MAC address "UAP" to "LAP"
V4.2	2009-08-22	Remove BC57E687B-ITB-E4 from BOM
V4.3	2009-12-02	Modify page 3 PIN OUT mistake (Swap AIO0 and AIO1)
V4.4	2011-7-1	Add more order information
V4.5	2011-12-19	Add more order information BM153-32
V4.6	2013-01-10	Add BM153 Test board

Contact Information

Sunitec Enterprise Co., Ltd.

Head Office:

3F., No.98-1, Mincyuan Rd Sindian City, Taipei
County 231, Taiwan

Tel: 886-2-82191696

Fax: 886-2-82191676

<http://www.sunitec.com.tw>

China Factory:

No.2, Qilin Road 2, Run Tang Ind., Dan-Keng Village Fu
Ming Community, Guan-lan Town, BaoAn District,
Shenzhen Guangdong China

Tel: 86-755-29802983

Fax: 86-755-29802984

E-mail: sales@sunitec-cn.com or project@sunitec-cn.com

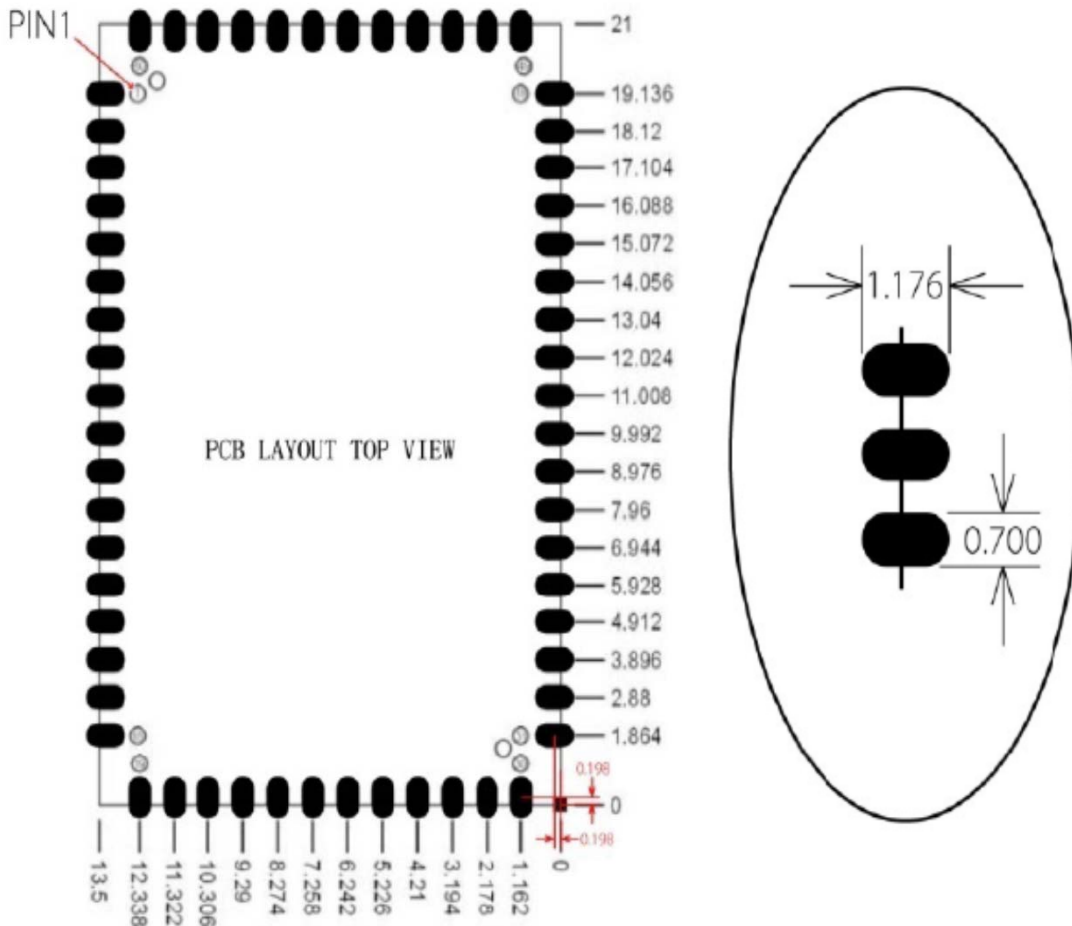
[Http://www.sunitec-cn.com](http://www.sunitec-cn.com)

SRS - X3

Construction of RF wireless part and Stability of power supply

Construction of wireless part

- 1、 The BT model BM153 has 60 pin.
- 2、 Every pin is fixed on main board by tin.
- 3、 The pad of every pin is about 1.176x0.7mm in main board
- 4、 The distanc of every pin is only 1.016mm in main board;
- 5、 How the BT model is fixed on main board as the following photo



Main Board

Internal Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Internal Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Bluetooth
Module

Internal Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Antenna



Internal Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Internal Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



External Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Front View



Back View



Top View

External Photo

Sony Corporation
Personal Audio System
[Model : SRS-X3]



Bottom View



Side View

FCC Statement

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

IC Statement

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

The end host device should bear the label which indicate "Contains FCC ID:AK8BM153" or "Contains IC:409B-BM153".